VSMY1943X01



Vishay Semiconductors

High Speed Infrared Emitting Diodes, 940 nm, Surface Emitter Technology



ADDITIONAL RESOURCES



DESCRIPTION

As part of the <u>SurfLightTM</u> portfolio, the VSMY1943X01 is an infrared, 940 nm emitting diode based on GaAlAs surface emitter chip technology with high radiant intensity, high optical power and high speed, molded in clear, untinted 0805 plastic package for surface mounting (SMD).

FEATURES

- Package type: surface-mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- AEC-Q101 gualified
- Operating temperature range: -40 °C to +105 °C
- Peak wavelength: λ_p = 940 nm
- Angle of half sensitivity: $\phi = \pm 60^{\circ}$
- 0805 standard surface-mountable package
- Floor life: 168 h, MSL 3, according to J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Miniature light barrier
- Photointerrupters
- · Emitter source for proximity sensors

PRODUCT SUMMARY					
COMPONENT	I_e (mW/sr) at I_F = 50 mA	φ (°)	λ _p (nm)	t _r (ns)	
VSMY1943X01	6	± 60	940	5	

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VSMY1943X01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	0805	

Note

MOQ: minimum order quantity

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RoHS

COMPLIANT HALOGEN

FREE

GREEN (5-2008)

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ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Forward current		I _F	70	mA	
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I _{FM}	140	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	500	mA	
Power dissipation		Pv	120	mW	
Junction temperature		Тj	110	°C	
Operating temperature range		T _{amb}	-40 to +105	°C	
Storage temperature range		T _{stg}	-40 to +110	°C	
Soldering temperature	According to Fig. 10, J-STD-020	T _{sd}	260	°C	
Thermal resistance junction-to-ambient	EIA / JESD 51	R _{thJA}	280	K/W	

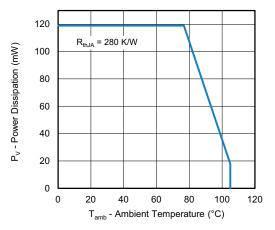


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

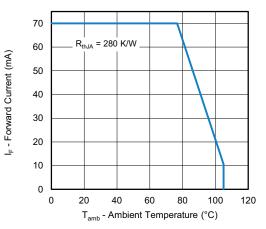


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 50 mA, t _p = 20 ms	V _F	-	1.4	1.7	V
	I _F = 70 mA, t _p = 20 ms	V _F	-	1.5	-	V
	$I_F = 500 \text{ mA}, t_p = 100 \ \mu \text{s}$	V _F	-	2.5	-	V
Reverse current		I _R	Not designed for reverse operation			μA
Junction capacitance	$V_R = 0 V, f = 1 MHz,$ E = 0 mW/cm ²	CJ	-	30	-	pF
Radiant intensity	$I_F = 50 \text{ mA}, t_p = 20 \text{ ms}$	l _e	4	6	8	mW/sr
Radiant Intensity	I _F = 1 A, t _p = 100 μs	I _e	-	80	-	mW/sr
Radiant power	I _F = 70 mA, t _p = 20 ms	фе	-	40	-	mW
Angle of half intensity		φ	-	± 60	-	0
Peak wavelength	I _F = 70 mA	λ _p	920	940	960	nm
Spectral bandwidth	I _F = 70 mA	Δλ	-	55	-	nm
Rise time	I _F = 70 mA, 10 % to 90 %	t _r	-	5	-	ns
Fall time	I _F = 70 mA, 10 % to 90 %	t _f	-	6	-	ns

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BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

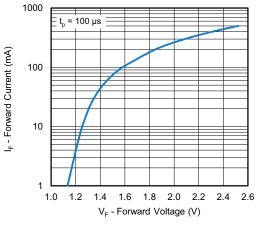


Fig. 3 - Forward Current vs. Forward Voltage

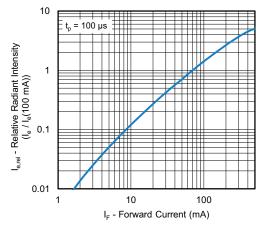
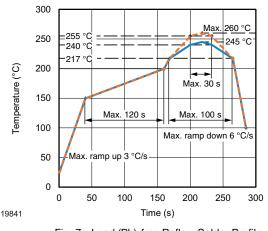
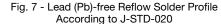


Fig. 4 - Relative Radiant Intensity vs. Ambient Temperature

REFLOW SOLDER PROFILE





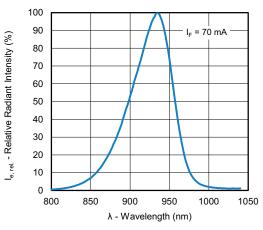
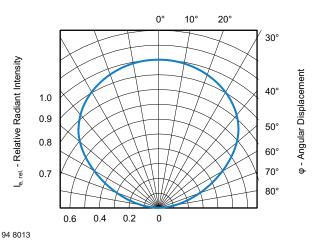


Fig. 5 - Relative Radiant Intensity vs. Wavelength





DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 3

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

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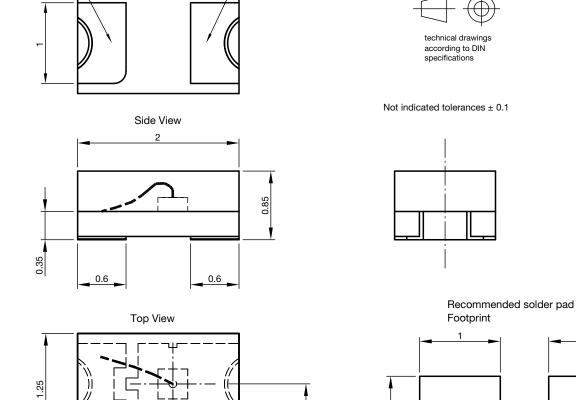
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Anode



Cathode

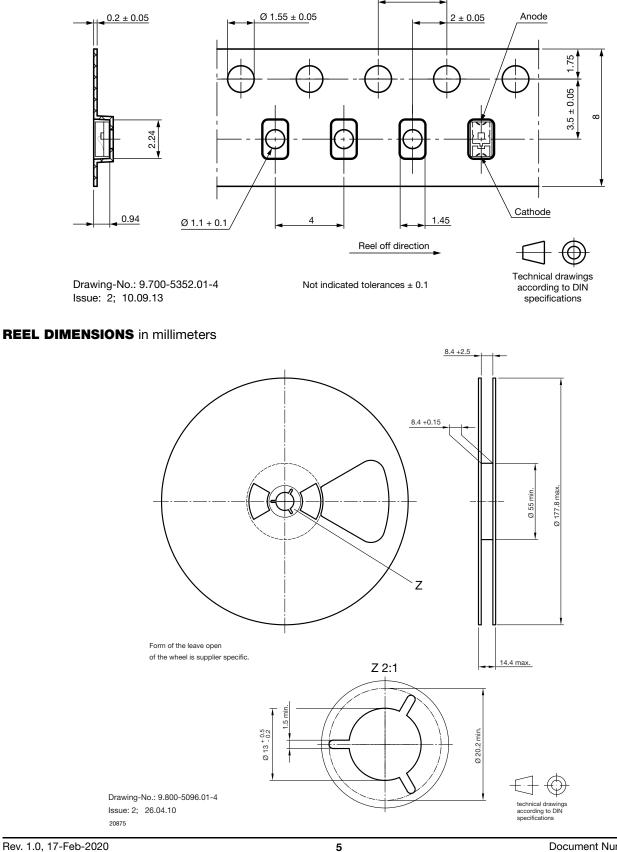


Bottom View





BLISTER TAPE DIMENSIONS in millimeters



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